Zener Transient Voltage Suppressor POWERMITE[®] Package

The 1PMT5.0AT1/T3 Series is designed to protect voltage sensitive components from high voltage, high energy transients. Excellent clamping capability, high surge capability, low Zener impedance and fast response time. The advanced packaging technique provides for a highly efficient micro miniature, space saving surface mount with its unique heatsink design. The POWERMITE has the same thermal performance as the SMA while being 50% smaller in footprint area, and delivering one of the lowest height profiles (1.1 mm) in the industry. Because of its small size, it is ideal for use in cellular phones, portable devices, business machines, power supplies and many other industrial/consumer applications.

Specification Features:

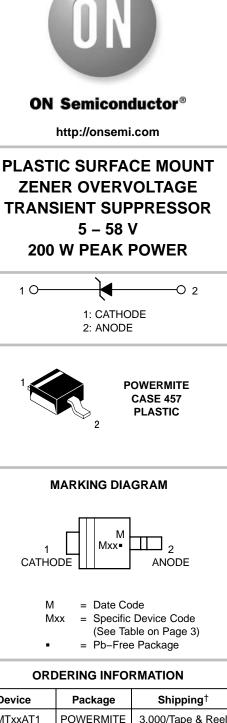
- Stand-off Voltage: 5.0 V 58 V
- Peak Power 200 W @ 1 ms (1PMT5.0A 1PMT36A)
 175 W @ 1 ms (1PMT40A 1PMT58A)
- Maximum Clamp Voltage @ Peak Pulse Current
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- Low Profile Maximum Height of 1.1 mm
- Integral Heatsink/Locking Tabs
- Full Metallic Bottom Eliminates Flux Entrapment
- Small Footprint Footprint Area of 8.45 mm²
- POWERMITE is JEDEC Registered as DO-216AA
- Lead Orientation in Tape: Cathode (Short) Lead to Sprocket Holes
- Cathode Indicated by Polarity Band
- Pb–Free Packages are Available

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic **FINISH:** All external surfaces are corrosion resistant and leads are readily solderable

MOUNTING POSITION: Any

MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES: 260°C for 10 Seconds



Device	Package	Shipping [†]
1PMTxxAT1	POWERMITE	3,000/Tape & Reel
1PMTxxAT1G	POWERMITE (Pb-Free)	3,000/Tape & Reel
1PMTxxAT3	POWERMITE	12,000/Tape & Reel
1PMTxxAT3G	POWERMITE (Pb-Free)	12,000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

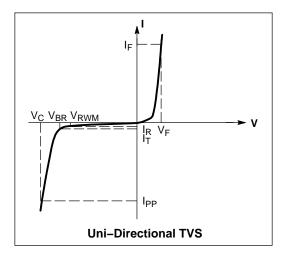
Rating	Symbol	Value	Unit
Maximum P_{pk} Dissipation, (PW–10/1000 μ s) (Note 1) (1PMT5.0A – 1PMT36A)	P _{pk}	200	W
Maximum P_{pk} Dissipation, (PW–10/1000 μ s) (Note 1) (1PMT40A – 1PMT58A)	P _{pk}	175	W
Maximum P_{pk} Dissipation, (PW-8/20 μ s) (Note 1)	P _{pk}	1000	W
DC Power Dissipation @ T _A = 25°C (Note 2) Derate above 25°C Thermal Resistance, Junction–to–Ambient	P _D R _{θJA}	500 4.0 248	mW mW/°C °C/W
Thermal Resistance, Junction-to-Lead (Anode)	$R_{\theta Janode}$	35	°C/W
Maximum DC Power Dissipation (Note 3) Thermal Resistance, Junction-to-Tab (Cathode)	P_D $R_{ hetaJcathode}$	3.2 23	W °C/W
Operating and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- 1. Nonrepetitive current pulse at $T_A = 25^{\circ}$ C. 2. Mounted with recommended minimum pad size, DC board FR-4. 3. At Tab (Cathode) temperature, $T_{tab} = 75^{\circ}$ C

Symbol	Parameter
I _{PP}	Maximum Reverse Peak Pulse Current
V _C	Clamping Voltage @ IPP
V _{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
V_{BR}	Breakdown Voltage @ I _T
Ι _Τ	Test Current
١ _F	Forward Current
VF	Forward Voltage @ I _F

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, V_F = 3.5 V Max. @ I_F (Note 4) = 35 A)



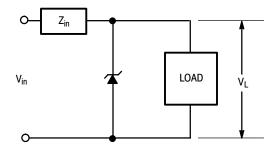
		V _{RWM}	V _{BR} @ I _T (V) (Note 6)			Ι _Τ	I _R @ V _{RWM}	V _C @ I _{PP}	I _{PP} (A)
Device*	Marking	(Note 5)	Min	Nom	Max	(mA)	(μΑ)	(V)	(Note 7)
1PMT5.0AT1, T3, G	MKE	5.0	6.4	6.7	7.0	10	50	9.2	21.7
1PMT7.0AT1, T3, G	MKM	7.0	7.78	8.2	8.6	10	30	12	16.7
1PMT12AT1, T3, G	MLE	12	13.3	14.0	14.7	1.0	1.0	19.9	10.1
1PMT16AT1, T3, G	MLP	16	17.8	18.75	19.7	1.0	1.0	26	7.7
1PMT18AT1, T3	MLT	18	20.0	21.0	22.1	1.0	1.0	29.2	6.8
1PMT22AT1, T3	MLX	22	24.4	25.6	26.9	1.0	1.0	35.5	5.6
1PMT24AT1, T3	MLZ	24	26.7	28.1	29.5	1.0	1.0	38.9	5.1
1PMT26AT1, T3	MME	26	28.9	30.4	31.9	1.0	1.0	42.1	4.8
1PMT28AT1, T3, G	MMG	28	31.1	32.8	34.4	1.0	1.0	45.4	4.4
1PMT30AT1, T3, G	MMK	30	33.3	35.1	36.8	1.0	1.0	48.4	4.1
1PMT33AT1, T3, G	MMM	33	36.7	38.7	40.6	1.0	1.0	53.3	3.8
1PMT36AT1, T3	MMP	36	40.0	42.1	44.2	1.0	1.0	58.1	3.4
1PMT40AT1, T3	MMR	40	44.4	46.8	49.1	1.0	1.0	64.5	2.7
1PMT48AT1, T3	MMX	48	53.3	56.1	58.9	1.0	1.0	77.4	2.3
1PMT51AT1, T3	MMZ	51	56.7	59.7	62.7	1.0	1.0	82.4	2.1
1PMT58AT1, T3	MNG	58	64.4	67.8	71.2	1.0	1.0	93.6	1.9

ELECTRICAL CHARACTERISTICS (T_I = 30°C unless otherwise noted, V_F = 1.25 Volts @ 200 mA)

4. 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.
5. A transient suppressor is normally selected according to the Working Peak Reverse Voltage (V_{RWM}) which should be equal to or greater than the DC or continuous peak operating voltage level.
6. V_{BR} measured at pulse test current I_T at ambient temperature of 25°C.
7. Surge current waveform per Figure 2 and derate per Figure 4.

*The "G" suffix indicates Pb-Free package available.

TYPICAL PROTECTION CIRCUIT



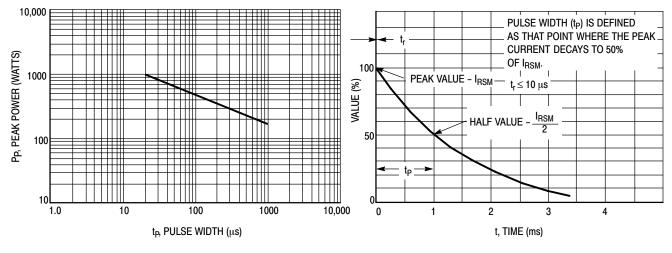


Figure 1. Pulse Rating Curve

Figure 2. 10 X 1000 μs Pulse Waveform

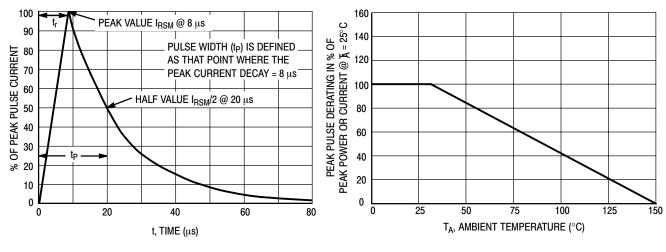


Figure 3. 8 X 20 μs Pulse Waveform



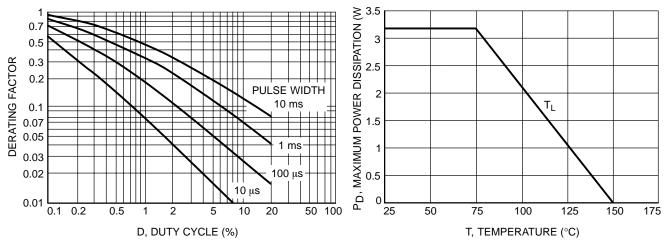
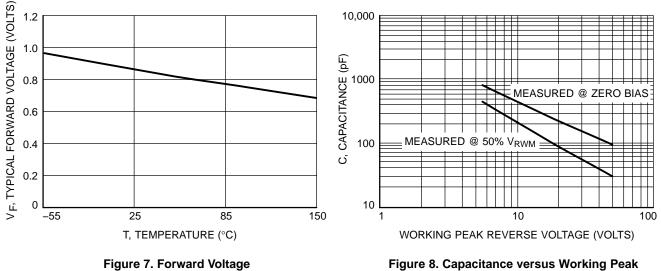


Figure 5. Typical Derating Factor for Duty Cycle

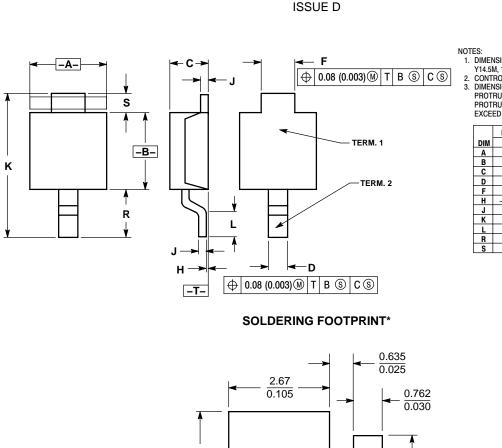




Reverse Voltage

OUTLINE DIMENSIONS

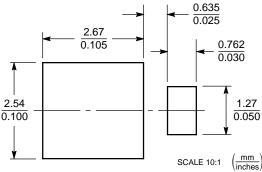
POWERMITE CASE 457-04



DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	1.75	2.05	0.069	0.081	
В	1.75	2.18	0.069	0.086	
С	0.85	1.15	0.033	0.045	
D	0.40	0.69	0.016	0.027	
F	0.70	1.00	0.028	0.039	
Н	-0.05	+0.10	-0.002	+0.004	
J	0.10	0.25	0.004	0.010	
K	3.60	3.90	0.142	0.154	
L	0.50	0.80	0.020	0.031	
R	1.20	1.50	0.047	0.059	
S	0.50	REF	0.019 REF		



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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